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| PATENT ASSIGNMENT COVER SHEET |
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Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6028341

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| SHUN WEN CHENG | 03/16/2020 |
| SHENG-LUNG CHANG | 03/16/2020 |
| CHIN-LANG WU | 03/16/2020 |
| YING-CHIEH CHAO | 03/16/2020 |
| SHIHN-JUH LIOU | 03/16/2020 |
| WEN-CHUNG LIANG | 03/16/2020 |
| RECEIVING PARTY DATA | |
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| Street Address: | NO. 195, SEC. 4, CHUNG HSING RD., CHUTUNG |
| City: | HSINCHU |
| State/Country: | TAIWAN |
| Postal Code: | 31057 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 16731449 |
| CORRESPONDENCE DATA | |
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| ATTORNEY DOCKET NUMBER: | 0941-4195PUS1 |
| NAME OF SUBMITTER: | TAN T. TU |
| SIGNATURE: | /TAN T. TU/ |
| DATE SIGNED: | 03/23/2020 |
| Total Attachments: 2 | |

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ASSIGNMENT

WHEREAS, Shun Wen CHENG, Sheng-Lung CHANG, Chin-Lang WU, Ying-Chieh CHAO, Shih-Juh LIOU and Wen-Chung LIANG hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: Composite material and foam prepared from the same

Filed: 31-Dec-2019 Serial No. 16/731,449

Executed on: March 16, 2020

WHEREAS, Industrial Technology Research Institute of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 31057, Taiwan, R. O. C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as

ly and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

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| Full name of sole or first inventor: Shun Wen CHENG | |
| Inventor's signature: <i>Shun Wen CHENG</i> | Date: 2020/3/16 |

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| Full name of second inventor: Sheng-Lung CHANG | |
| Inventor's signature: <i>Sheng Lung Chang</i> | Date: 2020/3/16 |

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| Full name of third inventor: Chin-Lang WU | |
| Inventor's signature: <i>Chin-Lang Wu</i> | Date: 2020/3/16 |

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| Full name of fourth inventor: Ying-Chieh CHAO | |
| Inventor's signature: <i>Ying-Chieh Chao</i> | Date: 2020/3/16 |

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| Full name of fifth inventor: Shih-Juh LIOU | |
| Inventor's signature: <i>Shih-Juh LIU</i> | Date: 2020/3/16 |

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|---|-----------------|
| Full name of sixth inventor: Wen-Chung LIANG | |
| Inventor's signature: <i>Wen-Chung Liang</i> | Date: 2020/3/16 |